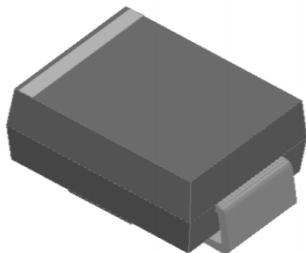


Surface Mount Schottky Barrier Rectifier
Reverse Voltage - 20 to 200 V
Forward Current - 3.0A



Features

- Metal silicon junction, majority carrier conduction
- For surface mounted applications
- Low power loss, high efficiency
- High forward surge current capability
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications

MECHANICAL DATA

- Case: SMA
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 60mg / 0.0021oz

Absolute Maximum Ratings and Electrical characteristics

Ratings at 25 °C ambient temperature unless otherwise specified. Single phase, half wave, 60Hz resistive or inductive load, for capacitive load, derate by 20 %

Parameter	Symbols	SS32A	SS34A	SS36A	SS310A	SS315A	SS320A	Units					
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	20	40	60	100	150	200	V					
Maximum RMS voltage	V_{RMS}	14	28	42	70	105	140	V					
Maximum DC Blocking Voltage	V_{DC}	20	40	60	100	150	200	V					
Maximum Average Forward Rectified Current	$I_{F(AV)}$	3.0						A					
Peak Forward Surge Current, 8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I_{FSM}	80						A					
Max Instantaneous Forward Voltage at 3 A	V_F	0.55		0.70		0.85		0.95					
Maximum DC Reverse Current $T_a = 25^\circ C$ at Rated DC Reverse Voltage $T_a = 100^\circ C$	I_R	0.5 5		0.1 3		mA		mA					
Typical Junction Capacitance ⁽¹⁾	C_j	450			400			pF					
Typical Thermal Resistance ⁽²⁾	$R_{\theta JA}$	70						°C/W					
Operating Junction Temperature Range	T_j	-55 ~ +150						°C					
Storage Temperature Range	T_{stg}	-55 ~ +150						°C					

(1) Measured at 1 MHz and applied reverse voltage of 4 V D.C

(2) P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.

Fig.1 Forward Current Derating Curve

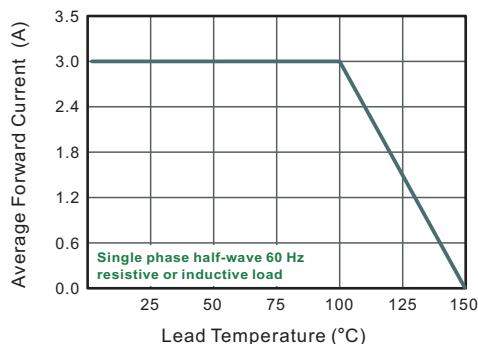


Fig.2 Typical Reverse Characteristics

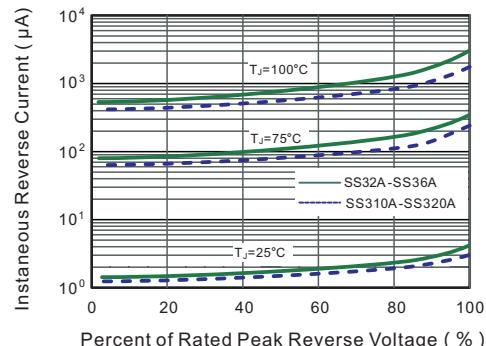


Fig.3 Typical Forward Characteristic

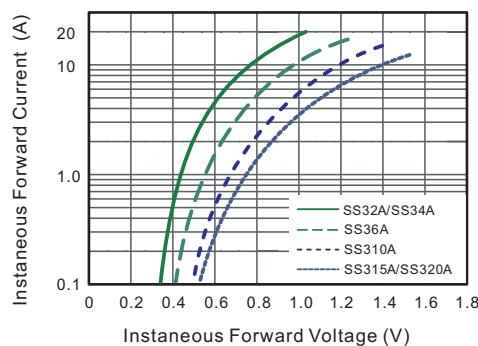


Fig.4 Typical Junction Capacitance

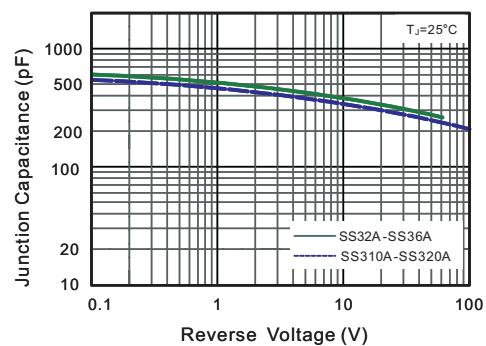


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

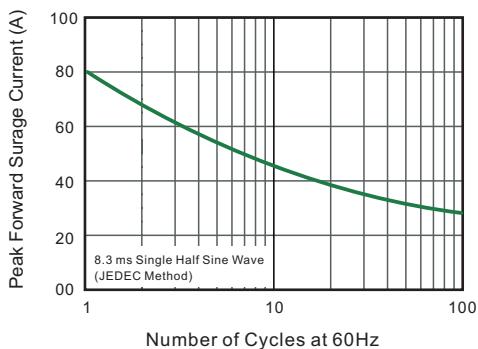
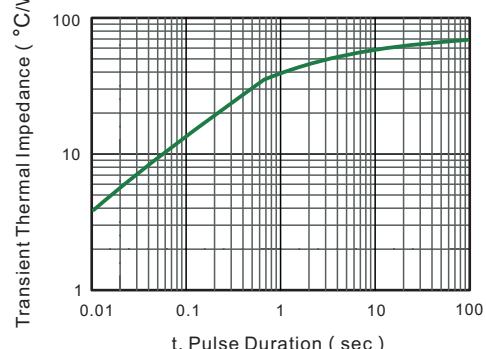
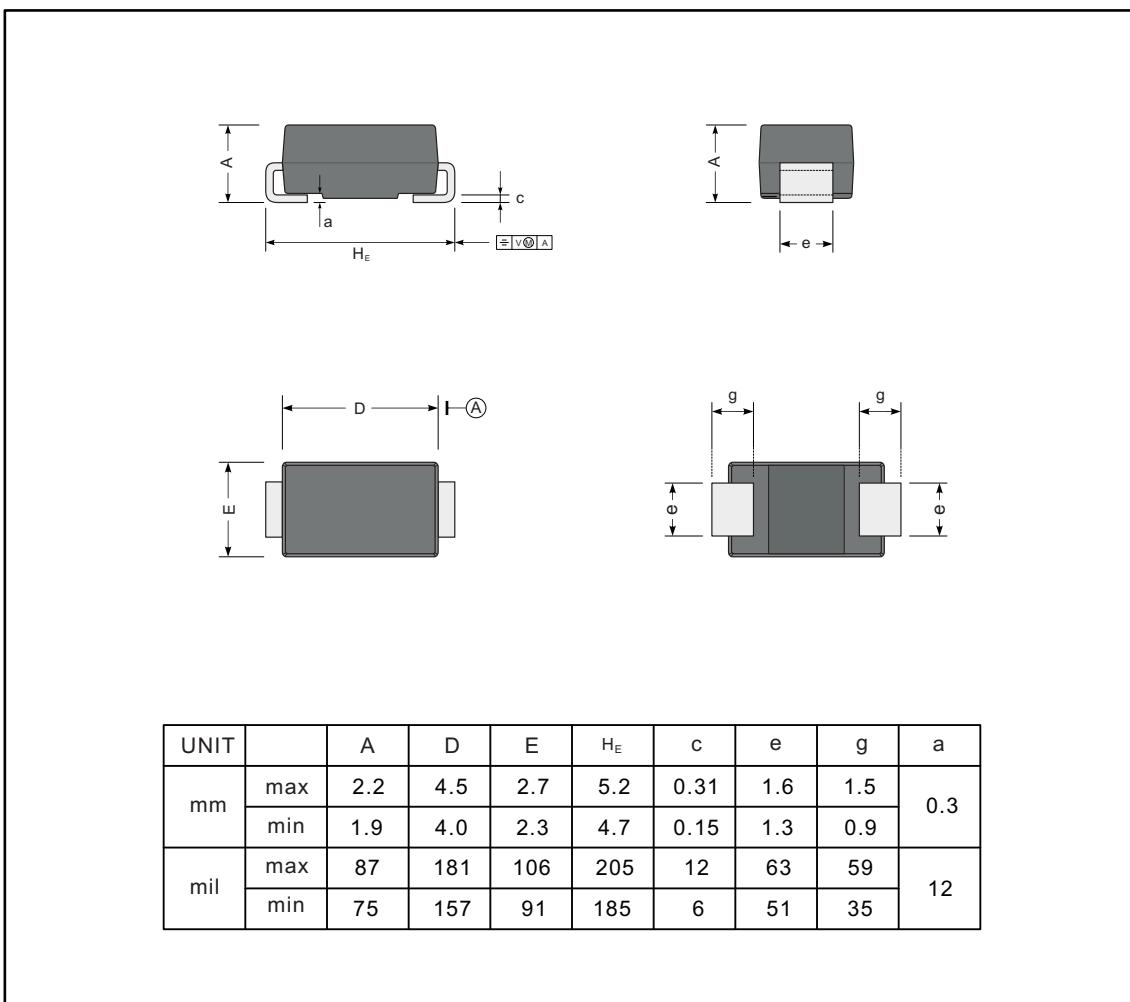
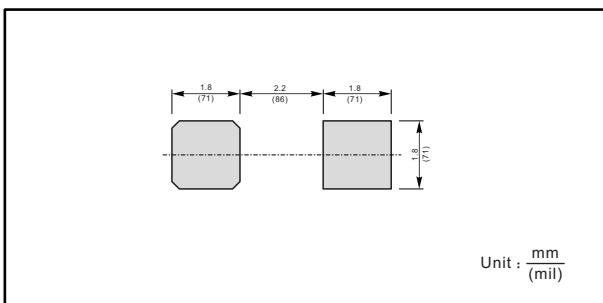


Fig.5- Typical Transient Thermal Impedance



PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SMA(DO-214AC)

The recommended mounting pad size

Marking

Type number	Marking code
SS32A	SS32
SS34A	SS34
SS36A	SS36
SS310A	SS310
SS315A	SS315
SS320A	SS320